



Our Vision

To be the foundry of choice for the analog world.



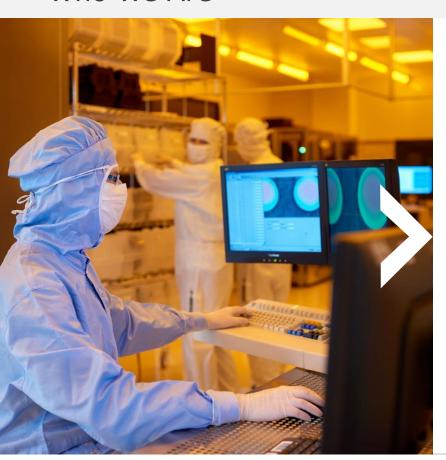


Our Mission

Enabling long-lasting success for all our stakeholders, focusing on innovative solutions and manufacturing excellence which meet customer expectations.

Who We Are





We are **digitizing the real world** enabling smart applications.

We develop **semiconductor technologies** and corresponding design IP to enable our customers to efficiently design their products and be successful.

We are a reliable, top quality and longterm manufacturing partner understanding customers and market needs and offer solutions with large value creation.

Where We Differ





We are a specialty foundry **offering unique combination** of analog/mixed-signal, high-voltage and embedded non-volatile memory options with sensor and actuator integration.

We support **long product lifecycles of 20+ years** and focus on automotive, industrial and medical end markets.

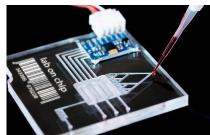
We provide **best-in-class design** and **prototyping support** to enable first-time-right design.

All of our sites are **automotive certified**.









More Than Making Chips



AUTOMOTIVE



Electrifying vehicles

- High voltage technologies for battery control, In-Vehicle Networks or power conversion
- Sensing of motion, pressure, temperature, positions and other physical values

INDUSTRIAL



Powering motion

- > Efficient power conversion
- > Silicon Carbide (SiC) as perfect alternative to silicon through increased efficiency, lower power loss, faster switching speed and higher operating temperatures

MEDICAL



Saving lives

- Advanced applications like cell sorters, DNA sequencers and biomedical screening
- > Technology for pacemakers, x-ray detectors, ultrasound probes or hearing aids

COMMUNICATION

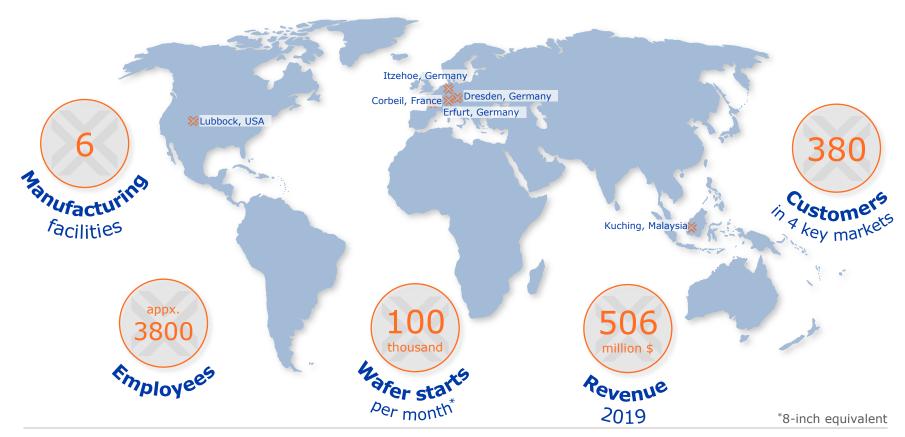


Connecting people

- Radio Frequency (RF) functionality as core element of high-performing communication devices
- Latest generation RF SOI devices are key for RF functionality enabling optimal communication experience

X-FAB At A Glance





X-FAB Technology Portfolio



CMOS

13 process families with over 450 options

SOI

Ease of design for high voltage and RF

SiC

First 6 inch foundry worldwide

MEMS

MEMS with or without integrated CMOS



Strong support from design to manufacturing

CMOS Technology Offering



	Digital	Analog	Mixed- signal	High Voltage	NVM	RF	Opto	SOI	High Temp
0.13 μm	€	€	€		€	€		€	
0.18 μm	\checkmark	\checkmark	\checkmark	\bigcirc	\bigcirc	\bigcirc	\bigcirc	\bigcirc	\bigcirc
0.25 μm	€	€	€		€				
0.35 μm	\bigcirc	\bigcirc	\bigcirc	\bigcirc	\bigcirc	\bigcirc	\bigcirc		\bigcirc
0.6 µm	€	€	€	€	€	€	€	€	€
0.8 µm	\bigcirc	\bigcirc	\checkmark	\bigcirc	\bigcirc		\bigcirc		
1.0 µm	€	€	€	€	€		€	€	€

Explore online

X-FAB's large portfolio of CMOS & SOI processes:

The FeatureXplorer

Best-in-class Support





X-FAB Worldwide



USA, TEXAS



LUBBOCK



CORBEIL



ITZEHOE



ERFURT



DRESDEN



KUCHING

Process focus:SiC, CMOS, BiCMOS, SOI

Capacity: 26,000 wafer starts per month

Wafer size:

Main nodes: 1.0 μm, 0.8 μm, 0.6 μm

Process focus: CMOS, RF-SOI

Capacity: 35,000 wafer starts per month

Wafer size:

Main nodes: 0.18 μm, 0.13 μm **Process focus:** MFMS

Capacity: N/A

Wafer size:

Main nodes: N/A

Process focus: CMOS, MEMS, BiCMOS, SOI

Capacity: 21,000 wafer starts per month

Wafer size: 6" for CMOS, 6" + 8" for MEMS

Main nodes: 1.0 μm, 0.8 μm, 0.6 μm

Process focus: CMOS, GaN-on-Si, MEMS

Capacity: 8,000 wafer starts per month

Wafer size: 8"

Main nodes: 0.6 μm, 0.35 μm

Process focus: CMOS, HV-SOI

Capacity: 30,000 wafer starts per month

Wafer size:

Main nodes: 0.35 μ m, 0.25 μ m, 0.18 μ m

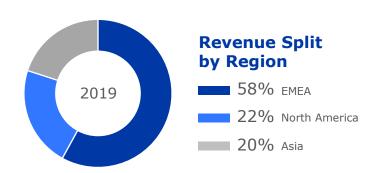
All quoted capacity numbers exclude MEMS

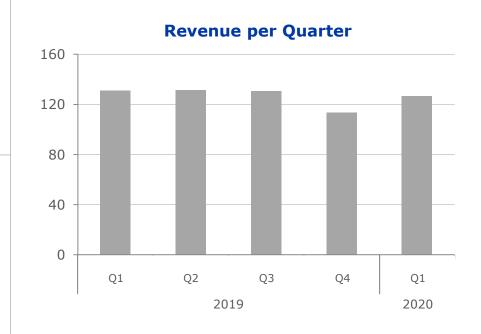
Revenue by Region



Revenue of \$ 506.4 million in 2019

down 14% year-on-year





Revenue by End Markets





